

PNP -100mA -50V Digital Transistor (Bias Resistor Built-in Transistor)

Parameter	Value
V_{CC}	-50V
I _{C(MAX.)}	-100mA
R ₁	4.7kΩ
R ₂	10kΩ

Features

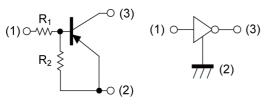
- 1) Built-In Biasing Resistors, $R_1 = 4.7k\Omega$, $R_2 = 10k\Omega$
- Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit).
- 3) Only the on/off conditions need to be set for operation, making the circuit design easy.
- 4) Complementary NPN Types: DTC143X series

Application

INVERTER, INTERFACE, DRIVER

•Inner circuit

DTA143XM/ DTA143XEB/ DTA143XUB

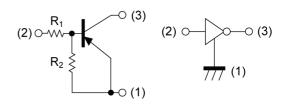


- (1) IN (BASE)
- (2) GND (+) (EMITTER)
- (3) OUT (COLLECTOR)

Outline

SOT-723	SOT-416FL
DTA143XM	DTA143XEB
(VMT3)	(EMT3F)
SOT-416	SOT-323FL
DTA143XE	DTA143XUB
(EMT3)	(UMT3F)
SOT-323	SOT-346
(1)	(2)

DTA143XE/ DTA143XUA/ DTA143XKA



- (1) GND (+) (EMITTER)
- (2) IN (BASE)
- (3) OUT (COLLECTOR)

Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
DTA143XM	SOT-723	1212	T2L	180	8	8000	33
DTA143XEB	SOT-416FL	1616	TL	180	8	3000	33
DTA143XE	SOT-416	1616	TL	180	8	3000	33
DTA143XUB	SOT-323FL	2021	TL	180	8	3000	33
DTA143XUA	SOT-323	2021	T106	180	8	3000	33
DTA143XKA	SOT-346	2928	T146	180	8	3000	33

● **Absolute maximum ratings** (T_a = 25°C)

Pa	arameter	Symbol	Values	Unit
Supply voltage	V _{CC}	-50	V	
Input voltage			-20 to 7	V
Output current		Io	-100	mA
Collector current			-100	mA
	DTA143XM		150	mW
	DTA143XEB		150	
Davis a dia sia atia a	DTA143XE	D *2	150	
Power dissipation	DTA143XUB	P _D *2	200	
	DTA143XUA		200	
	DTA143XKA		200	
Junction temperature	T _j	150	°C	
Range of storage temperat	ture	T _{stg}	-55 to +150	°C

• Electrical characteristics $(T_a = 25^{\circ}C)$

Darameter	Symbol .	Conditions	Values			Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Offic
lanut voltore	$V_{l(off)}$	$V_{CC} = -5V, I_{O} = -100 \mu A$	-	-	-0.3	V
Input voltage	V _{I(on)}	$V_O = -0.3V$, $I_O = -20$ mA	-2.5	-	-	V
Output voltage	V _{O(on)}	I _O = -10mA, I _I = -0.5mA	1	-100	-300	mV
Input current	l _l	V _I = -5V	1	-	-1.8	mA
Output current	I _{O(off)}	$V_{CC} = -50V, V_{I} = 0V$	1	-	-500	nA
DC current gain	G _I	$V_{O} = -5V, I_{O} = -10mA$	30	-	-	-
Input resistance	R ₁	-	3.29	4.7	6.11	kΩ
Resistance ratio	R ₂ /R ₁	-	1.7	2.1	2.6	-
Transition frequency	f _T *1	V _{CE} = -10V, I _E = 5mA, f = 100MHz	-	250	-	MHz

^{*1} Characteristics of built-in transistor

^{*2} Each terminal mounted on a reference land.

●Electrical characteristic curves (T_a =25°C)

Fig.1 Input voltage vs. output current (ON characteristics)

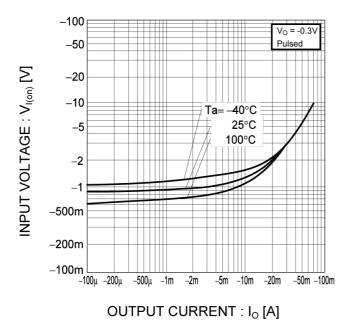


Fig.2 Output current vs. input voltage (OFF characteristics)

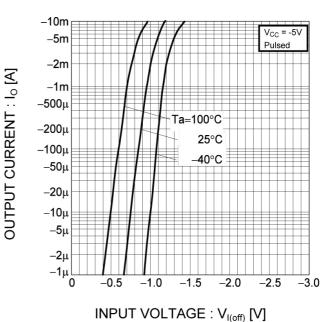


Fig.3 Output current vs. output voltage

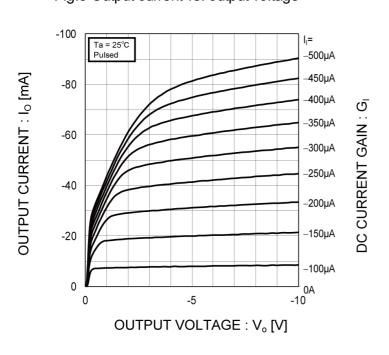
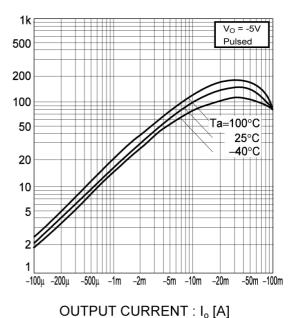
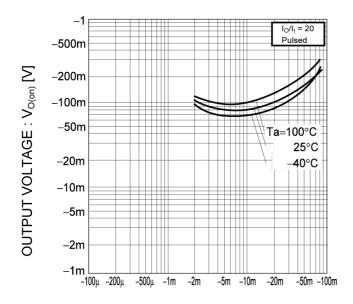


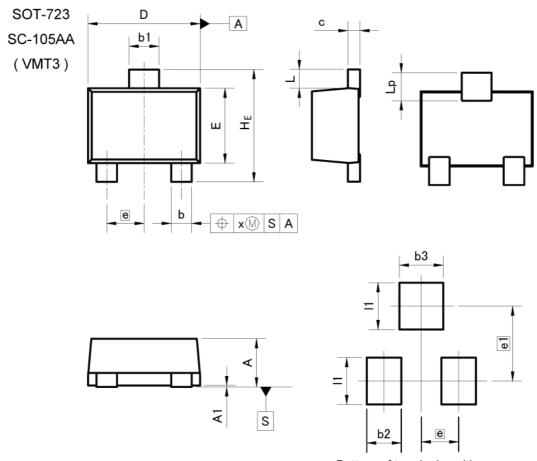
Fig.4 DC current gain vs. output current



●Electrical characteristic curves (T_a =25°C)

Fig.5 Output voltage vs. output current





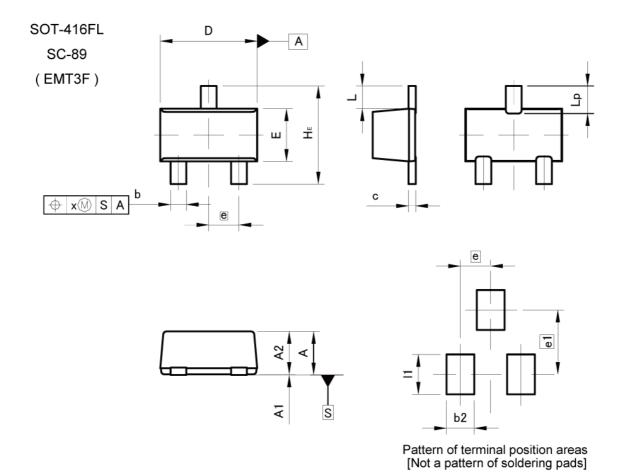
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM MILIME		ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	0.45	0.55	0.018	0.022
A1	0.00	0.10	0.000	0.004
b	0.17	0.27	0.007	0.011
b1	0.27	0.37	0.011	0.015
С	0.08	0.18	0.003	0.007
D	1.10	1.30	0.043	0.051
E	0.70	0.90	0.028	0.035
е	0.4	40	0.0	02
HE	1.10	1.30	0.043	0.051
L	0.10	0.30	0.004	0.012
Lp	0.20	0.40	0.008	0.016
x	-	0.10	ı	0.004

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
b2	-	0.37	ı	0.015
b3	_	0.47	7-	0.019
e1	0.80		0.0	31
11	-	0.50	_	0.020

Dimension in mm/inches



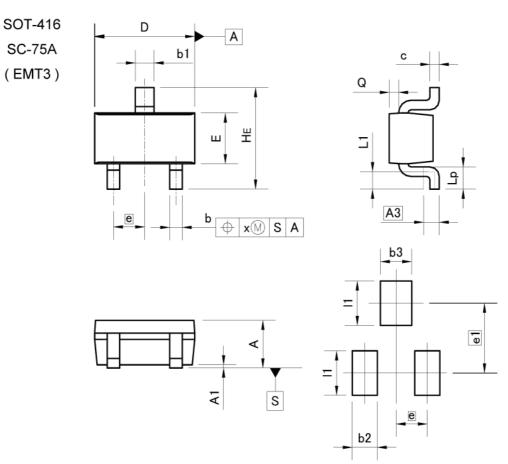


	MILIMETERS		INCHES	
DIM	IVIILLIVII	ETERS	INCHES	
DIW	MIN	MAX	MIN	MAX
Α	0.65	0.85	0.026	0.033
A1	0.00	0.10	0.000	0.004
A2	0.60	0.80	0.024	0.031
b	0.21	0.36	0.008	0.014
С	0.08	0.18	0.003	0.007
D	1.50	1.70	0.059	0.067
E	0.76	0.96	0.030	0.038
е	0.	50	0.0	20
HE	1.50	1.70	0.059	0.067
L	0.3	37	0.0	15
Lp	0.35	0.55	0.014	0.022
х	_	0.10	-	0.004

DIM	MILIMETERS		INCHES		
DIM	MIN	MAX	MIN	MAX	
b2	_	0.46	_	0.018	
e1	_	1.05	-	0.041	
- 11	-	0.65	-	0.026	

Dimension in mm/inches





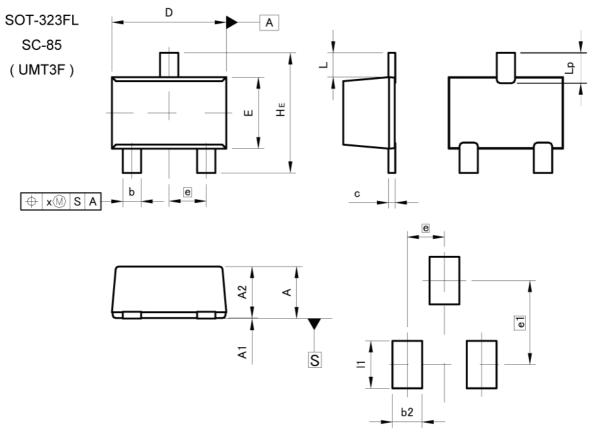
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	0.60	0.80	0.024	0.031
A1	0.00	0.10	0.000	0.004
A3	0.	25	0.0	10
b	0.15	0.30	0.006	0.012
b1	0.25	0.40	0.010	0.016
С	0.10	0.20	0.004	0.008
D	1.50	1.70	0.059	0.067
E	0.70	0.90	0.028	0.035
е	0.	50	0.0	20
HE	1.40	1.80	0.055	0.071
L1	0.10	-	0.004	-
Lp	0.15		0.006	% -
Q	0.05	0.25	0.002	0.010
х	\ -	0.10	, - ,	0.004

DIM	MILIM	MILIMETERS		HES
DIM	MIN	MAX	MIN	MAX
b2	1	0.40	-	0.016
b3	I	0.50	-	0.020
e1	1.10		0.0	143
l1	i -	0.70	-	0.028

Dimension in mm/inches





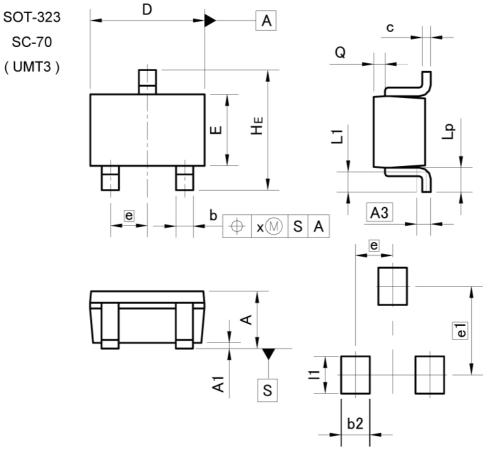
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	0.85	1.05	0.033	0.041
A1	0.00	0.10	0.000	0.004
A2	0.80	1.00	0.031	0.039
b	0.27	0.42	0.011	0.017
С	0.08	0.18	0.003	0.007
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.0	65	0.0	26
HE	2.00	2.20	0.079	0.087
L	0.4	43	0.0	17
Lp	0.43	0.63	0.017	0.025
х	_	0.10	-	0.004

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
b2	_	0.52	_	0.020
e1	1.47		0.058	
11	-	0.83	-	0.033

Dimension in mm/inches





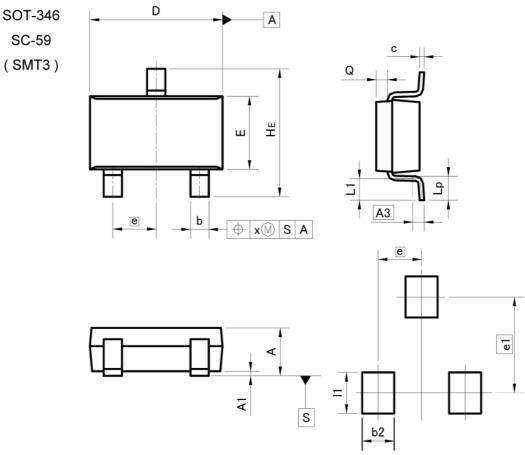
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	0.80	1.00	0.031	0.039
A1	0.00	0.10	0	0.004
A3	3 0.25		0.01	
b	0.25	0.40	0.01	0.016
С	0.10	0.20	0.004	0.008
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.65		0.03	
HE	2.00	2.20	0.079	0.087
L1	0.20	0.50	0.008	0.02
Lp	0.25	0.55	0.01	0.022
Q	0.10	0.30	0.004	0.012
х	_	0.10	_	0.004

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
e1	1.55		0.06	
b2	- 0.50		1	0.02
11	_	0.65	_	0.026

Dimension in mm/inches





Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	1.00	1.30	0.039	0.051
A1	0.00	0.10	0.000	0.004
A3	0.25		0.010	
b	0.35	0.50	0.014	0.020
С	0.09	0.25	0.004	0.010
D	2.80	3.00	0.110	0.118
E	1.50	1.80	0.059	0.071
е	0.95		0.037	
HE	2.60	3.00	0.102	0.118
L1	0.30	0.60	0.012	0.024
Lp	0.40	0.70	0.016	0.028
Q	0.20	0.30	0.008	0.012
х	-,	0.10	-	0.004
У	- ,,	0.10	e	0.004

	DIM	MILIMETERS		INCHES	
		MIN	MAX	MIN	MAX
	b2	-	0.60	-	0.024
	e1	2.10		0.083	
	11	ľ	0.90	-	0.035

Dimension in mm/inches



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JAPAN	USA	EU	CHINA
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CLASSIV	CLASSIII	CLASSⅢ	CLASSIII

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 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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